

**IN THE CLAIMS**

1. (Currently Amended) A sacrificial coating material comprising:  
at least one inorganic compound, and  
at least one material modification agent, wherein the sacrificial coating material is  
transparent from a wavelength of 193nm to about 365nm and dissolvable in  
an alkaline-based chemistry or a fluorine-based chemistry.
2. (Original) The sacrificial coating material of claim 1, wherein the inorganic  
compound comprises a silicon-based compound.
3. (Original) The sacrificial coating material of claim 2, wherein the silicon-based  
compound comprises at least one siloxane compound, at least one silazane  
polymer, dimethylsiloxane, diphenylsiloxane, methylphenylsiloxane, at least one  
silicate polymer, at least one silicic acid derivative, and mixtures thereof.
4. (Original) The sacrificial coating material of claim 3, wherein the at least one  
siloxane compound comprises methylsiloxane, methylsilsesquioxane,  
phenylsiloxane, phenylsilsesquioxane, methylphenylsiloxane,  
methylphenylsilsesquioxane or combinations thereof.
5. (Original) The sacrificial coating material of claim 2, wherein the at least one silicon-  
based compound comprises at least one hydrogensiloxane polymer having the  
general formula  $(H_{0-1.0}SiO_{1.5-2.0})_x$ , at least one hydrogensilsesquioxane polymer  
having the formula  $(HSiO_{1.5})_x$ , where x is greater than about four and derivatives of  
silicic acid or a combination thereof.
6. (Original) The sacrificial coating material of claim 2, wherein the at least one silicon-  
based compound comprises copolymers of hydrogensilsesquioxane and an  
alkoxyhydridosiloxane or hydroxyhydridosiloxane.
7. (Original) The sacrificial coating material of claim 2, wherein the silicon-based

compound comprises acrylic siloxane polymers, silsesquioxane-based polymers, derivatives of silici acid, organohydridosiloxane polymers of the general formula  $(H_{0-1.0}SiO_{1.5-2.0})_n(R_{0-1.0}SiO_{1.5-2.0})_m$ , organohydridosilsesquioxane polymers of the general formula  $(HSiO_{1.5})_n(RSiO_{1.5})_m$ , where m is greater than zero and the sum of n and m is greater than about four and R is alkyl or aryl, and combinations thereof.

8. (Original) The sacrificial coating material of claim 7, wherein the organohydridosiloxane polymer comprises methylhydridosiloxanes, ethylhydridosiloxanes, propylhydridosiloxanes, t-butylhydridosiloxanes, phenylhydridosiloxanes and combinations thereof.
9. (Previously Presented) The sacrificial coating material of claim 7, wherein the silsesquioxane-based polymer comprises methylhydridosilsesquioxanes, ethylhydridosilsesquioxanes, propylhydridosilsesquioxanes, t-butylhydridosilsesquioxanes, phenylhydridosilsesquioxanes, and combinations thereof.
10. (Original) The sacrificial coating material of claim 1, wherein the at least one material modification agent comprises at least one porogen, at least one adhesion promoter, at least one densifying agent, at least one leveling agent, at least one high-boiling solvent, at least one catalyst, at least one pH tuning agent, at least one capping agent or at least one replacement solvent.
11. (Original) The sacrificial coating material of claim 1, wherein the alkaline-based chemistry comprises an amine-based compound.
12. (Original) The sacrificial coating material of claim 11, wherein the amine-based compound comprises a primary amine, a secondary amine, a tertiary amine or a combination thereof.
13. (Original) The sacrificial coating material of claim 12, wherein the amine-based compound comprises TMAH.
14. (Original) A transparent via fill coating layer comprising the material of claim 1.

15. (Original) The transparent via fill coating layer of claim 14, wherein the layer is sacrificial.
16. (Original) A layered material, comprising:  
the via fill coating layer of claim 14,  
an absorbing composition layer, and  
a photoresist layer.
17. (Original) The layered material of claim 16, wherein the layered material is coupled to a dielectric layer.
18. (Currently Amended) A method of producing a sacrificial coating material, comprising:  
providing at least one inorganic compound,  
providing at least one material modification agent,  
combining the at least one inorganic compound with the at least one material modification agent to form the sacrificial coating material, wherein the sacrificial coating material is transparent from a wavelength of 193nm to about 365nm and dissolvable in an alkaline-based chemistry or a fluorine-based chemistry.
19. (Original) The method of claim 18, wherein the inorganic compound comprises a silicon-based compound.
20. (Original) The method of claim 19, wherein the silicon-based compound comprises at least diphenylsiloxane, methylphenylsiloxane, at least one silicate polymer, at least one silicic acid derivative, and mixtures thereof.
21. (Original) The method of claim 20, wherein the at least one siloxane compound comprises methylsiloxane, methylsilsesquioxane, phenylsiloxane, phenylsilsesquioxane, methylphenylsiloxane, methylphenylsilsesquioxane or combinations thereof.

22. (Original) The method of claim 19, wherein the at least one silicon-based compound comprises at least one hydrogensiloxane polymer having the general formula  $(H_{0-1.0}SiO_{1.5-2.0})_x$ , at least one hydrogensilsesquioxane polymer having the formula  $(HSiO_{1.5})_x$ , where x is greater than about four and derivatives of silicic acid or a combination thereof.
23. (Original) The method of claim 19, wherein the at least one silicon-based compound comprises copolymers of hydrogensilsesquioxane and an alkoxyhydrosiloxane or hydroxyhydrosiloxane.
24. (Original) The method of claim 19, wherein the silicon-based compound comprises acrylic siloxane polymers, silsesquioxane-based polymers, derivatives of silicic acid, organohydrosiloxane polymers of the general formula  $(H_{0-1.0}SiO_{1.5-2.0})_n(R_{0-1.0}SiO_{1.5-2.0})_m$ , organohydrosilsesquioxane polymers of the general formula  $(HSiO_{1.5})_n(RSiO_{1.5})_m$ , where m is greater than zero and the sum of n and m is greater than about four and R is alkyl or aryl, and combinations thereof.
25. (Original) The method of claim 24, wherein the organohydrosiloxane polymer comprises methylhydrosiloxanes, ethylhydrosiloxanes, propylhydrosiloxanes, t-butylhydrosiloxanes, phenylhydrosiloxanes and combinations thereof.
26. (Original) The method of claim 24, wherein the silsesquioxane-based polymer comprises methylhydrosilsesquioxanes, ethylhydrosilsesquioxanes, propylhydrosilsesquioxanes, t-butylhydrosilsesquioxanes, phenylhydrosilsesquioxanes, and combinations thereof.
27. (Original) The method of claim 18, wherein the at least one material modification agent comprises at least one porogen, at least one adhesion promoter, at least one densifying agent, at least one leveling agent, at least one high-boiling solvent, at least one catalyst, at least one pH tuning agent, at least one capping agent or at least one replacement solvent.
28. (Original) The method of claim 18, wherein the alkaline-based chemistry comprises an amine-based compound.

- 29. (Original) The method of claim 28, wherein the amine-based compound comprises a primary amine, a secondary amine, a tertiary amine or a combination thereof.
- 30. (Original) The method of claim 29, wherein the amine-based compound comprises TMAH.
- 31. (Original) A transparent via fill coating layer formed using the method of claim 18.
- 32. (Original) The transparent via fill coating layer of claim 30, wherein the layer is sacrificial.